

Data brief

SensorTile connectable sensor node: solder only



Product summary SensorTile connectable STEVAL-STLCS02V1 sensor node: solder only Ultra-low-power microcontroller STM32L476JG with FPU ARM Cortex-M4 Bluetooth low energy network processor BlueNRG-MS supporting Bluetooth 4.1 core specification e-Compass with 3D digital linear acceleration LSM303AGR sensor, 3D digital magnetic sensor Ultra-compact piezoresistive LPS22HB absolute pressure sensor iNEMO 6DoF LSM6DSM inertial module **Applications** Sensing

Features

- Very compact module for motion, audio, environmental sensing and Bluetooth[®] low energy connectivity with a complete set of firmware examples
- Mobile connectivity via the STBLESensor app, available for iOS™ and Android™
- Main components:
 - STM32L476JG 32-bit ultra-low-power MCU with Cortex[®]M4F
 - LSM6DSM iNEMO inertial module: 3D accelerometer and 3D gyroscope
 - LSM303AGR Ultra-compact high-performance eCompass module: ultralow power 3D accelerometer and 3D magnetometer
 - LPS22HB MEMS nano pressure sensor: 260-1260 hPa absolute digital output barometer
 - MP34DT05-A 64 dB SNR digital MEMS microphone
 - BlueNRG-MS Bluetooth low energy network processor
 - BALF-NRG-02D3 50 Ω balun with integrated harmonic filter
 - LD39030SJ18R 300 mA low quiescent current soft-start, low noise voltage regulator
- 2 V 5.5 V power supply range
- External interfaces: UART, SPI, SAI (Serial Audio Interface), I²C, DFSDM, USB OTG, ADC, GPIOs
- Solderable only interface (no connector on back side)
- · SWD interface for debugging and programming capability
- CE certified
- · RoHS and China RoHS compliant
- WEEE compliant
- FCC certified
- · IC certified
- TYPE certified

Description

STEVAL-STLCS02V1 (SensorTile) is a highly integrated reference design that can be plugged into form-factor prototypes, adding sensing and connectivity capabilities to new designs through a smart hub solution.

It can also easily support development of monitoring and tracking applications like standalone sensor nodes connected to $iOS^{\intercal M}$ or Android $^{\intercal M}$ smartphone applications.

The SensorTile occupies a very small $13.5 \times 13.5 \text{ mm}$ square outline, with all the electronic components on the top side. The connector pinout is repeated on 18 PCB pads to render the SensorTile a solderable system on module.

Refer to user manual UM2101 *Getting started with the STEVAL-STLKT01V1* SensorTile integrated development platform for more information.



1 Schematic diagram

Integrated LDO **VDD** 1.8V antenna (1.9 - 5.5 V) MP34DT05-A Vin2 >= VDD VDDIO2 **BALF-NRG-02D3** (VDD - 3.3 V) **VDDUSB** Integrated balun 32 KHz LSM6DSM BlueNRG-MS STM32L4 LSM303AGR SPI 4-wire ortex-M4F 80 MHz 2.5 MHz 5 MHz LPS22HB 32 MHz UART LP-UART 2 x GPIO NRST I2C 2 x ADC I2S USB (SWD) PDM

Figure 1. Functional block diagram

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2 Regulatory approvals

The SensorTile module STEVAL-STLCS02V1 is marketed under the same FCC identifier (ID: S9NSTILE01) as the SensorTile kit (code STEVAL-STLKT01V1) and the SensorTile module STEVAL-STLCS01V1 as a class I permissive change. The FCC ID S9NSTILE01 is a limited modular approval as the module does not have RF shielding. The radio transmitter was tested for FCC certification in the specific host with model number STEVAL-STLCX01V1, belonging to the SensorTile kit (code STEVAL-STLKT01V1). When integrated in a custom designed host, the SensorTile module STEVAL-STLCS02V1 must be tested and FCC certified in the custom designed host.

The SensorTile module STEVAL-STLCS02V1 is marketed under the same IC certification number IC: 8976C-STILE01 as a class I permissive change to model number HVIN: STEVAL-STLCS01V1. Please refer to the data brief of the SensorTile kit (code STEVAL-STLKT01V1) for complete information on PMN, FVIN and HMN. The SensorTile module is certified as a limited module because the modular transmitter does not have RF shielding. The radio transmitter was tested in the representative host with model number STEVAL-STILECX01V1, belonging to the SensorTile kit (code STEVAL-STLKT01V1). When the SensorTile module is integrated into a different custom designed host, the developer of the host shall perform additional radiated emission test and meet technical requirements and labeling requirements as per RSP100 section 3.2 http://www.ic.gc.ca/eic/site/smt-gst.nsf/eng/sf01130.html for IC certification.

The Bluetooth radio power output is set by default at 0 dBm. The FCC and IC certifications refer to this operating value. The power output can be changed up to 8 dBm by reprogramming the device firmware, but the change of this operating value will require an update of the FCC and IC certifications, with additional radio emission tests to be performed.

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Revision history

Table 1. Document revision history

Date	Version	Changes
28-Mar-2017	1	Initial release.
09-Nov-2017	2	Updated features in cover page.
05-Mar-2019	3	Updated cover page features. Added product summary table.
13-Mar-2019	4	Updated cover page features.
01-Feb-2021	5	Updated cover page features and product summary table.

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